L Number	Hits	Search Text	DB	Time stamp
1	0	semi-conductor adj manufacturing near database	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 13:28
2	361	manufacturing near database	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 12:05
3	0	6775630.URPN.	USPAT	2004/09/09 11:54
4	4	("5777901" | "6148307" | "6292582" | "6332110").PN.	USPAT	2004/09/09 11:54
5	5	6148307.URPN.	USPAT	2004/09/09 11:56
6	1	semiconductor adj data adj management	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 12:07
7	13	manufacturing adj data adj management	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 13:16
8	61	5463555.URPN.	USPAT	2004/09/09 12:10
9	1	("6332110").PN.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 13:16
10	5	6332110.URPN.	USPAT	2004/09/09 13:17
11	4	("5777901" | "6148307" | "6292582" | "6332110").PN.	USPAT	2004/09/09 13:18
12	65	semiconductor adj manufacturing near database	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 13:31
13	27981	semiconductor adj manufacturing adjdatabase	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 13:35
14	0	semiconductor adj manufacturing adj database	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 13:35
15	225	manufacturing adj database	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 14:23
16	24	5777876.URPN.	USPAT	2004/09/09 13:46
17	0	6766212.URPN.	USPAT	2004/09/09 13:51
18	20	("5586021" | "5646870" | "5655110" | "5691895" | "5740341" | "5774689" | "5777876" | "5841659" | "5884079" | "5929855" | "5966519" | "5980078" | "5999911" | "6006193" | "6036345" | "6195594" | "6233537" | "6249768" | "6336053" | "6467077").PN.	USPAT	2004/09/09 13:51
19	3429	semiconductor near (maintenance adj information or data)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 14:59
20	8	("5375229" | "5754451" | "5787021" | "5872970" | "6314379" | "6438440" | "6466945" | "6556881" | "2003/0109945").PN.	USPAT	2004/09/09 14:30
21	2	5375229.URPN.	USPAT	2004/09/09 14:37
22	1	("20020103620").PN.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 14:59
23	21	apparatus near (maintenance adj system)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 15:15

24	0	semiconductor near apparatus near (maintenance adj system)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 15:16
25	5	manufacturing near (maintenance adj system)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 15:16
26	69	5216612.URPN.	USPAT	2004/09/09 15:19
27	0	6381508.URPN.	USPAT	2004/09/09 15:24
–	50	("5590342" "5801894" "5990868" "5961566" "6232820" "4305360" "4511762" "4782751" "4864438" "4890304" "4949336" "5023872" "5226145" "5291420" "5357510" "5381414" "5396635" "5404536" "5410664" "5422871" "5423017" "5428807" "5432917" "5473765" "5493663" "5513156" "5542064" "5544169" "5546568" "5551044" "5555399" "5570361" "5579085" "5583986" "5608426" "5611069" "5630165" "5640510" "5655126" "5663959" "5692202" "5691494" "5710929" "5740087" "5752011" "5758175" "5768141" "5771393" "5771394" "5781783").pn.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 09:22

		48	("5787296" "5790895" "5790873" "5797115" "5799198" "5799177" "5805586" "5805982" "5815724" "5835435" "5845140" "5845755" "5856789" "5859524" "5860222" "5864712" "5872639" "5881297" "5884088" "5892959" "5898879" "5900026" "5901322" "5913067" "5967756" "5992964" "6000035" "6002688" "6018803" "6032271" "6044090" "6049883" "6072776" "6079025" "6078568" "6081849" "6085325" "6084857" "6091507" "6093500" "6121962" "6124810" "6134069" "6141627" "6141283" "6151303" "6151660" "6178486" "61819316199145").pn.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/08 15:08
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-		49	("6219728" "6219728" "6229737" "6230183" "6247040" "6338054" "6751741" "4285589" "4613780" "4622835" "4796451" "4889226" "4909057" "4914934" "4918962" "4932190" "5449282" "6314601" "6385000" "5339437" "6175568" "5953536" "5970954" "4835776" "5369771" "5504910" "5774059" "5825869" "5845138" "5901148" "5921218" "5974394" "6216187" "6216187" "3618045" "3665487" "3639912" "4139739" "4245317" "4244334" "4246639" "4248196" "4264960" "4283603" "4335694" "4344076" "4346440" "4347575" "4348668" "4358825").pn.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 07:32

—	53	("4368512" "4383747" "4391294" "4401077" "4408100" "4419667" "4419666" "4419665" "4425766" "4429528" "4430907" "4538570" "4551972" "4633404" "4757217" "4758980" "4783026" "4794521" "4799192" "4811230" "4813675" "4817094" "4831819" "4843219" "4849878" "4852343" "4854164" "4862849" "4872182" "4872594" "4887260" "4912626" "4926335" "4937822" "4942821" "4945870" "4951192" "4964142" "4965728" "4980044" "4991082" "4991198" "5003533" "5010515" "5018171" "5018385" "5020058" "5068892" "5063575" "5046182").pn.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/08 15:14
—	1	("20020103620").PN.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/08 15:28
—	1559	702/182	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 07:33
—	34	702/182 and (710/$.ccls.)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 07:45
—	97	apparatus adj management adj system	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 07:46
—	4	6230183.URPN.	USPAT	2004/09/09 08:03
—	12	("5225997" | "5282127" | "5347346" | "5361265" | "5548535" | "5650940" | "5786994" | "5919258" | "6021284" | "6032001" | "6108492" | "6571147").PN.	USPAT	2004/09/09 08:05

–	5	manufacturing adj apparatus adj management adj system	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 08:20
–	1	manufacturing adj apparatus adj management adj method	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 08:21
–	42	apparatus adj management adj method	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 08:28
–	2	improving adj equipment adj productivity	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 08:37
–	0	6728591.URPN.	USPAT	2004/09/09 08:29
–	11	("4345968" | "5270222" | "5576629" | "5578161" | "6060328" | "6081334" | "6161054" | "6268293" | "6486675" | "6548414" | "6625514" | "2002/0155629" | "2003/0010750").PN.	USPAT	2004/09/09 08:30
–	37	5576629.URPN.	USPAT	2004/09/09 08:30
–	11	apparatus adj management adj program	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 08:42
–	6607	358/1.15	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 08:44
–	237	358/1.15 and (710/$.ccls.)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 08:49
–	27	semi-conductor adj apparatus	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 08:52
–	180	tsmc	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 08:52
–	20	4758980.URPN.	USPAT	2004/09/09 09:22
–	42	apparatus adj management adj method	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 10:02
–	0	6785583.URPN.	USPAT	2004/09/09 09:28
–	1	("6253240").PN.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 10:03
–	0	(2002/0100013).CCLS.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 10:04
–	1	("20020100013").PN.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 10:20
–	1	("5974562").PN.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 10:21
–	1	("6122639").PN.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 10:23

-	1	("6360255").PN.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 10:25
-	1131	716/19	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/09/09 11:50